

General Description

The AP3700/A is a green-mode pulse width modulation (PWM) controller. It is specially designed for low power applications such as off-line battery chargers, where the needs for low standby power, space saving and low cost are all required. In a battery charger rated 5V/1A, the maximum standby power is only 0.18W.

In normal operation, the AP3700/A switches on and off at a fixed switching frequency of 60 kHz. With a current limit capability of 460mA for AP3700 and 500mA for AP3700A, the AP3700/A can directly drive the emitter of high voltage NPN transistor. When output power falls below a given level, the IC enters skip cycle mode to reduce power consumption.

The AP3700/A also features under-voltage lockout, over-current and short circuit protections.

The AP3700/A is available in TO-92 package.

Mar. 2008 Rev. 1. 4

Features

- Current Mode Control with Skip Cycle Capability
- Lower Operating Current: 0.45mA
- Fixed Switching Frequency: 60 kHz
- Frequency Dithering for Low EMI: ±2.5kHz
- Under-Voltage Lockout Protection
- Over-Current Protection
- Internal Short Circuit Protection
- Higher Output Voltage at OUT Terminal
- Low Total Cost Solution

Applications

- · Battery Chargers
- Off-Line Power Supplies

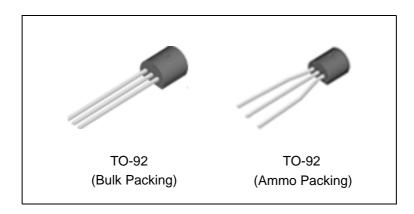


Figure 1. Package Types of AP3700/A



Pin Configuration

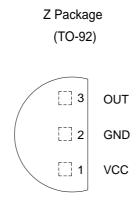


Figure 2. Pin Configuration of AP3700/A (Top View)

Pin Description

Pin Number	Pin Name	Function		
1	VCC	The power supply of the IC, and is generally connected to opto-coupler's emitter		
2	GND	Supply ground		
3	OUT	The output pin, connected to the emitter of NPN transistor or the source of MOSFET		



AP3700/A

Functional Block Diagram

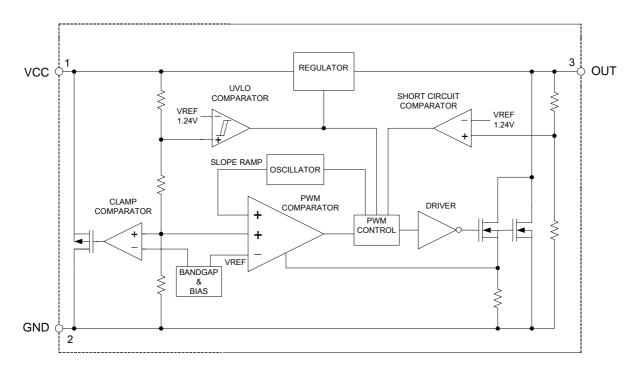


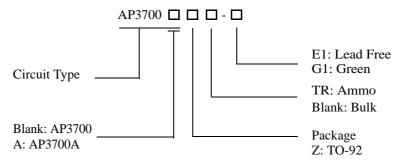
Figure 3. Functional Block Diagram of AP3700/A

AP3700/A



LOW POWER PWM CONTROLLER FOR OFF-LINE BATTERY CHARGER

Ordering Information



Package	Switching Frequency	Temperature Range	Part Number		Mark	Packing Type	
			Lead Free	Green	Lead Free	Green	
TO-92 60kl			AP3700Z-E1	AP3700Z-G1	3700Z-E1	3700Z-G1	Bulk
	60kHz	-40 to 85°C	AP3700ZTR-E1	AP3700ZTR-G1	3700Z-E1	3700Z-G1	Ammo
	OOKITZ	-40 to 85°C	AP3700AZ-E1	AP3700AZ-G1	3700AZ-E1	3700AZ-G1	Bulk
			AP3700AZTR-E1	AP3700AZTR-G1	3700AZ-E1	3700AZ-G1	Ammo

BCD Semiconductor's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant. Products with "G1" suffix are available in green packages.

Absolute Maximum Ratings (Note 1)

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Parameter	Value	Unit
Supply Voltage	-0.3 to 6.0	V
Voltage at OUT (Note 2)	-0.3 to 40	V
Output Current at OUT	Internally limited	A
Power Dissipation	0.6	W
Operating Junction Temperature	150	°C
Storage Temperature	-65 to 150	°C
Lead Temperature (Soldering, 10s)	300	°C
ESD (Machine Model)	200	V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Note 2: The Breadown Voltage. The actual operating voltage can not be greater than the value listed here.



Electrical Characteristics

(V_{CC} =4V, T_J =25 o C, unless otherwise specified.)

Parameter	Symbol	Conditions		Min	Тур	Max	Unit	
UVLO SECTION		1	l			I		
Start-up Voltage	V _{TH (ST)}			5.00	5.25	5.50	V	
Minimal Operating Voltage	V _{OPR} (min)	V _{OPR} (min)		3.4	3.65	3.9	V	
STANDBY CURRENT SEC	CTION				I	I		
Start-up Current (Note 3)	I _{ST}	V _{CC} =4V			0.22	0.4	0.4 mA	
Operating Current	I _{CC(OPR)}				0.45	0.7	ША	
V _{CC} Zener Voltage	$V_{\rm Z}$	I _{CC} =10mA	6	6.3		V		
Dynamic Impedance	R _{VCC}	V _{CC} =3.8 to 4.8V			18		kΩ	
INTERNAL OSCILLATOR								
Switching Frequency	F_{SW}		50	60	75	kHz		
Frequency Dither				±2	±2.5	±3	kHz	
Temperature Stability					5	8	%	
DRIVE OUTPUT SECTION	N							
OUT Start-up Voltage	V_{ST}				8.5	11	V	
Short Circuit Threashold Voltage (Note 4)	V _{SC}				6		V	
Rise Time	T_{R}	$C_L=1$ nF, 15 Ω pull-up			60		ne	
Fall Time	T_{F}	C_L =1nF, 15 Ω pull-up			30		ns	
Maximum Duty Cycle	D _{MAX}	$V_{OPR}(min) + 0.2V$		67	75	84	%	
Minimum Duty Cycle		V _{CC} =V _{TH (ST)} -0.2V			3		/0	
Driver OUT On-Resistance	R _{OUT}	I _{OUT} =0.06A			3		Ω	
Switch Off Current (OUT)		Driver off, V _{OUT} =10V			20	40	μΑ	
Effective Current Limit	I _{LIM}	$V_{CC} = V_{OPR} + 0.1V$	For AP3700	460			mA	
			For AP3700A	500				
OUT Current Coefficient	G_{A}		'		-0.3		A/V	

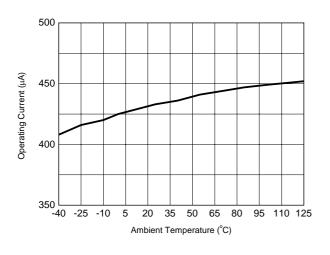
Note 3: AP3700/A is an emitter drive controller, the PWM controller will start up only when the voltage on the OUT pin rises up to its threshould value.

Note 4: AP3700/A performs its short circuit function by shutdown the OUT pulse when the OUT pin voltage drops below its short circuit threshold value.



AP3700/A

Typical Performance Characteristics



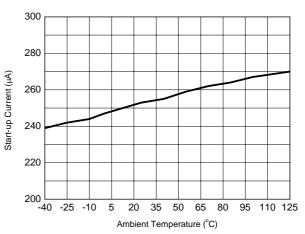
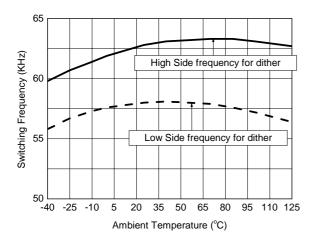


Figure 4. Operating Current vs. Ambient Temperature

Figure 5. Start-up Current vs. Ambient Temperature



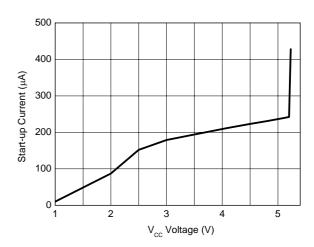


Figure 6. Switching Frequency vs. Ambient Temperature

Figure 7. Start-up Current vs. V_{CC} Voltage



AP3700/A

Function Description

1. Startup Circuit

Figure 3 is the functional block diagram of AP3700/A, and there are 3 external pins: the VCC pin, the OUT pin and GND pin. In typical application shown by Figure 10, the VCC pin is used for both bias supply and feedback control. The OUT pin directly drives external NPN transistor or MOSFET, and also provides initial bias power for UVLO comparator. When the IC works in PWM mode, the auxiliary winding will supply the $\rm V_{CC}$ enough operating current.

Figure 8 shows the start-up sequence of the V_{CC} and the $V_{OUT}\!\!$

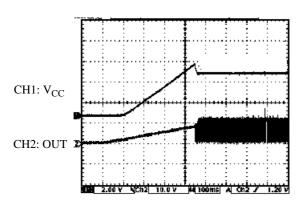


Figure 8. Start-up Sequence of V_{CC} and V_{OUT}

2. V_{CC}/Feedback Control

An opto-coupler and secondary constant voltage/current controller consists of voltage feedback network. When load is heavy, the voltage on VCC will be lower to enlarge duty cycle; on the contrary, if load drops, the voltage on VCC will rise to reduce duty cycle.

3. Frequency Dither

Frequency dither is performed by periodically spreading a single switching frequency into adjacent frequency band, so the peak energy is spread. This technique can improve EMI by reducing both quasipeak and average EMI emissions.

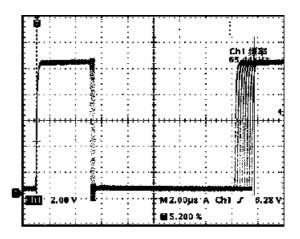


Figure 9. Frequency Dither Influences the Swithcing Cycle

AP3700/A has reference switching frequency of 60 kHz, and its frequency deviation is ± 2.5 kHz in period of 2ms. Figure 9 shows the frequency dither influence to the waveform .

4. Current Limit Control

The AP3700/A employs current mode control to improve transient response and voltage stability. In Figure 10, the external inductor current through the OUT pin is converted to a voltage by an internal resistor, and this voltage will participate to control duty cycle and peak inductor current.

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AP3700/A

Typical Application

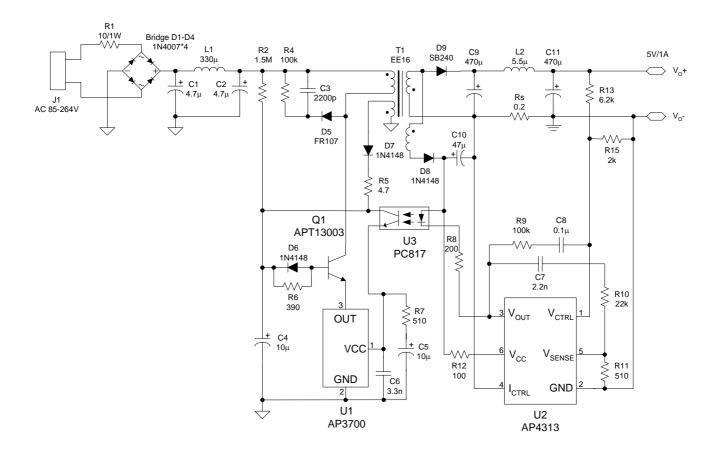
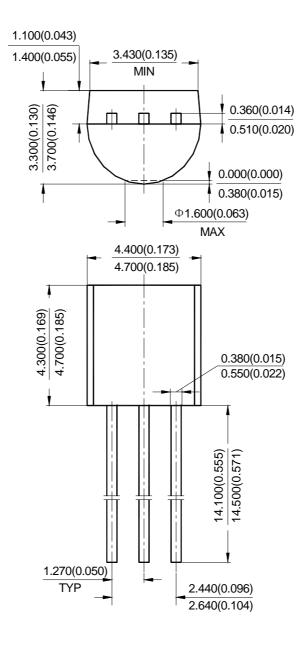


Figure 10. 5V/1A Output for Battery Charger of Mobile Phone



Mechanical Dimensions

TO-92 (Bulk Packing) Unit: mm(inch)

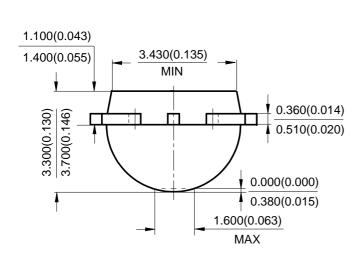


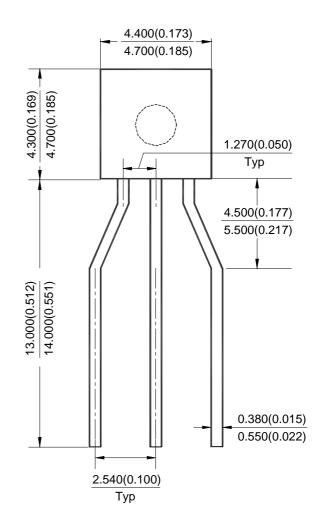


AP3700/A

Mechanical Dimensions (Continued)

TO-92 (Ammo Packing) Unit: mm(inch)









BCD Semiconductor Manufacturing Limited

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